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PATENT & TRADEMARK OFFICE

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FORM PTO-1449 (REV. 7-80)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	ATTY. DOCKET NO.: 57761.000108	SERIAL NO.: 10/063,985
LIST OF MATERIALS CITED BY APPLICANT (Use several sheets if necessary)		INVENTOR'S NAME: Allen M. Ritter, et al.	EXAMINER: Unassigned
		FILING DATE: May 31, 2002	GROUP 3743

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE
AR	A	6 0 1 8 4 5 9	01/25/00	Carlson, et al.			
	B	6 1 3 1 6 4 4	10/17/00	Kohara, et al.			
	C	6 1 3 1 6 5 0	10/17/00	North et al.			
	D	5 9 8 7 8 9 3	11/23/99	Schulz-Harder, et al.			
	E	6 0 1 4 3 1 2	01/11/00	Schulz-Harder et al.			
	F	5 8 4 1 6 3 4	11/24/98	Visser			
AR	G	5 2 0 5 3 5 3	04/27/93	Willemsen, et al.			
	H						
	I						
	J						
	K						
	L						
	M						
	N						
	O						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUB CLASS	TRANSLATION
							YES NO

OTHER MATERIALS (Including Author, Title, Date, Pertinent Pages, Etc.)

AR	"Fluid-Cooled DBC Substrates," by J. Schulz-Harder, K. Exel, and A. Meyer
AR	"Direct Bond Copper Substrates," from Thermalloy

EXAMINER	DATE CONSIDERED
Flanagan	12/9/03

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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